CLAIMS

| What is claimed | ıs | • |
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| 1 | | | DACKADE | CONTINUESTIC |
| | | | paonago | Comprising |
| • | | A photonic | P ~ 0.1. ~ 3 • | OOpo, |

- 2 a housing;
- a semiconductor light source disposed within the housing, the semiconductor
- 4 light source having a first light beam output having data encoded thereon;
- a beam splitter cube (BSC) disposed inside the housing to create a first split
- 6 output of said first light beam output, said BSC having a light beam splitting
- 7 characteristic that negatively impacts said encoding of said data in said first light
- 8 beam within a predetermined limited threshold; and
- g a photodetector disposed inside the housing to receive the first split output,
- with the photodetector being adapted to determine properties of the first split output
- 11 notwithstanding said first split output being created in said limited impact manner.
- 1 2. The photonic package of claim 1 further comprising
- a first lens, optically coupled to the semiconductor light source, the first lens
- 3 equipped to collimate the first light beam output,
- a second split output of said first light beam output created by the BSC, and
- a second lens, optically coupled to the BSC and an optical fiber, the second
- 6 lens equipped to focus the second split output to the optical fiber.
- 1 3. The photonic package of claim 1, wherein BSC comprises a BSC
- 2 incorporated with an electro-optic (EO) modulator.

- 1 4. The photonic package of claim 3, wherein the BSC further comprises a
- 2 cleaved yittrium-iron garnet type crystal.
- 1 5. The photonic package of claim 1, wherein the semiconductor light source
- 2 comprises a semiconductor laser.
- 1 6. The photonic package of claim 5, wherein the semiconductor laser comprises
- 2 a gallium arsenide based semiconductor laser.
- 1 7. The photonic package of claim 1, wherein the BSC comprises a nonpolarizing
- 2 dielectric BSC.
- 1 8. The photonic package of claim 7, wherein the nonpolarizing dielectric BSC
- 2 comprises a first right angle prism and a second right angle prism adhesively joined
- 3 at the hypotenuse.
- 1 9. The photonic package of claim 1, wherein the BSC comprises a BSC having
- 2 a dielectric material to create the first split output.
- 1 10. The photonic package of claim 1, wherein the predetermined limited threshold
- 2 comprises the first split output being of a percentage of the first light beam output.

- 1 11. The photonic package of claim 10, wherein the percentage of the first light
- 2 beam output is 2%.
- 1 12. The photonic package of claim 1, wherein the BSC comprises a BSC made of
- 2 a high quality glass.
- 1 13. The photonic package of claim 12, wherein the high quality glass is BK7A
- 2 glass.
- 1 14. The photonic package of claim 1, wherein the photodetector comprises a
- 2 photodiode.
- 1 15. The photonic package of claim 14, wherein the photodiode comprises a p-i-n
- 2 junction photodiode.
- 1 16. The photonic package of claim 1 further comprising a processor to receive
- 2 electrical signals from the photodetector.
- 1 17. The photonic package of claim 16, wherein the processor comprises a
- 2 processor having at least access to characterization data to facilitate calibration of
- 3 the received first split output.

| 1 | 18. | A method of monitoring a semiconductor light source utilizing a beamsplitter | | |
|----|-----------------------------------|-----------------------------------------------------------------------------------|--|--|
| 2 | cube | (BSC), comprising: | | |
| 3 | | generating a first light beam output by the semiconductor light source that is | | |
| 4 | inclu | ded in a housing, the first light beam output having data encoded thereon; | | |
| 5 | | providing the first light beam output to the BSC that is included in the housing, | | |
| 6 | the E | SC having a light beam splitting characteristic that negatively affects said | | |
| 7 | enco | ded data in said first light beam within a predetermined limited threshold; | | |
| 8 | | creating a first split output of the first light beam output at said BSC; and | | |
| 9 | | providing the first split output to a photodetector that is disposed within the | | |
| 10 | hous | ing, the photodetector adapted to determine properties of the first split output | | |
| 11 | notw | ithstanding the first split output being created in the limited impact manner. | | |
| | | | | |
| 1 | 19. | The method of claim 18 further comprising | | |
| 2 | | collimating the first light beam output; | | |
| 3 | | creating a second split output of the first light beam output at said BSC; | | |
| 4 | | optically coupling the BSC to an optical fiber; and | | |
| 5 | | focusing the second split output to the optical fiber. | | |
| | | | | |
| 1 | 20. | The method of claim 18 further comprising receiving electrical signals from | | |
| 2 | the photodetector at a processor. | | | |

- 1 21. The method of claim 20 further comprises calibrating the photodetector by the
- 2 processor for receiving the first split output.

| 1 | 22. | A photonic package comprising: |
|----|---------|----------------------------------------------------------------------------------|
| 2 | | a housing; |
| 3 | | a semiconductor light source disposed within the housing, the semiconductor |
| 4 | light s | ource having a first light beam output having data encoded thereon; |
| 5 | | an optical isolator structure optically coupled to the semiconductor light |
| 6 | sourc | e and disposed inside the housing, the optical isolator structure having a beam |
| 7 | splitte | er cube (BSC), the BSC having a light beam splitting characteristic that |
| 8 | negat | ively impacts said encoding of said data in said first light beam within a |
| 9 | prede | etermined threshold; and |
| 10 | | a photodetector disposed inside the housing to receive the first split output, |
| 11 | with t | he photodetector being adapted to determine properties of the first split output |
| 12 | notwi | thstanding said first split output being created in said limited impact manner. |
| | | |
| 1 | 23. | The photonic package of claim 22 further comprising |
| 2 | | a lens, optically coupled to the semiconductor light source, the lens equipped |
| 3 | to col | limate the first light beam output, |
| | | |

- a second split output of said first light beam output created by the BSC and
 being provided to an optical fiber.
- 1 24. The photonic package of claim 22, wherein the semiconductor light source
 2 comprises a semiconductor laser.

- 1 25. The photonic package of claim 24, wherein the semiconductor laser
- 2 comprises a gallium arsenide based semiconductor laser.
- 1 26. The photonic package of claim 22, wherein the BSC comprises a
- 2 nonpolarizing dielectric BSC.
- 1 27. The photonic package of claim 26, wherein the BSC comprises a BSC having
- 2 a dielectric material to create the first split output.
- 1 28. The photonic package of claim 22, wherein the BSC comprises a polarizing
- 2 dielectric BSC.
- 1 29. The photonic package of claim 28, wherein the BSC comprises a BSC having
- 2 a dielectric material to create the first split output.
- 1 30. The photonic package of claim 22, wherein the BSC comprises a cleaved
- 2 light isolator element.
- 1 31. The photonic package of claim 30, wherein the light isolator element
- 2 comprises a bismuth garnet.

- 1 32. The photonic package of claim 22, wherein the predetermined limited
- 2 threshold comprises the first split output being of a percentage of the first light beam
- 3 output.
- 1 33. The photonic package of claim 32, wherein the percentage of the first light
- 2 beam output is a maximum of 2%.